

QEE213

Plastic Infrared Light Emitting Diode

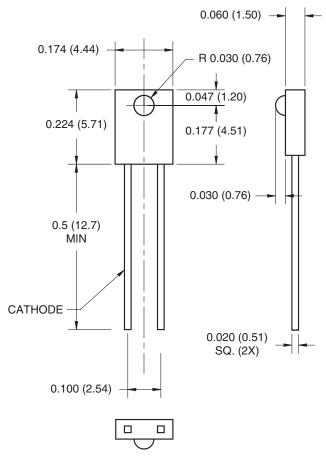
Features

- Wavelength = 940 nm, GaAs
- Package Type: Sidelooker
- Medium Beam Angle, 50°
- Clear Plastic Package
- Matched Photosensors: QSE213 and QSE243

Description

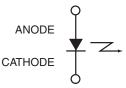
The QEE213 is a 940nm GaAs LED encapsulated in a medium angle, thin plastic sidelooker package.

Package Dimensions





Schematic



NOTES:

- 1. Dimensions for all drawings are in inches (millimeters).
- 2. Tolerance of \pm .010 (.25) on all non nominal dimensions unless otherwise specified.

Absolute Maximum Ratings (T_A = 25°C unless otherwise specified)

Parameter	Symbol	Rating	Unit
Operating Temperature	T _{OPR}	-40 to + 100	°C
Storage Temperature	T _{STG}	-40 to + 100	°C
Soldering Temperature (Iron) ^(2,3,4)	T _{SOL-I}	240 for 5 sec	°C
Soldering Temperature (Flow) ^(2,3)	T _{SOL-F}	260 for 10 sec	°C
Continuous Forward Current	I _F	100	mA
Reverse Voltage	V _R	5	V
Peak Forward Current ⁽⁵⁾	I _{FP}	1	A
Power Dissipation ⁽¹⁾	P _D	100	mW

Electrical/Optical Characteristics (T_A =25°C)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Units
Peak Emission Wavelength	I _F = 100 mA	I _P	_	940	_	nm
Emission Angle	I _F = 100 mA	U	_	±25	_	Deg.
Forward Voltage	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	V _F	_	_	1.5	V
Reverse Current	V _R = 5 V	I _R	_	_	10	μΑ
Radiant Intensity	$I_F = 100 \text{ mA}, t_p = 20 \text{ ms}$	I _e	2	_	_	mW/sr
Rise Time	I _F = 100 mA	t _r	_	1	_	μs
Fall Time	tp = 100 μs, T = 10 mS	t _f	_	1	_	

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Notes

- 1. Derate power dissipation linearly 2.67 mW/°C above 25°C.
- 2. RMA flux is recommended.
- 3. Methanol or isopropyl alcohols are recommended as cleaning agents.
- 4. Soldering iron 1/16" (1.6 mm) minimum from housing.
- 5. Pulse conditions: tp = 100 μ s, T = 10 ms.

Typical Performance Curves

Fig. 1 Forward Current vs. Forward Voltage

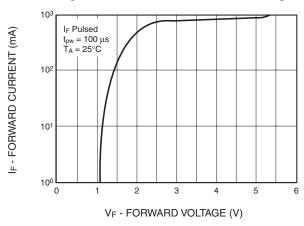


Fig. 2 Forward Voltage vs. Ambient Temperature

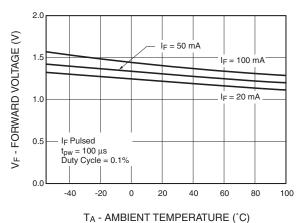


Fig. 3 Normalized Radiant Intensity vs. Forward Current

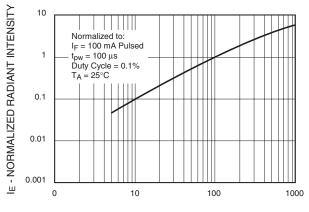
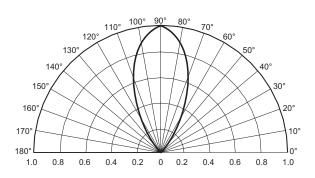


Fig. 4 Radiation Diagram



I_F - FORWARD CURRENT (mA)

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